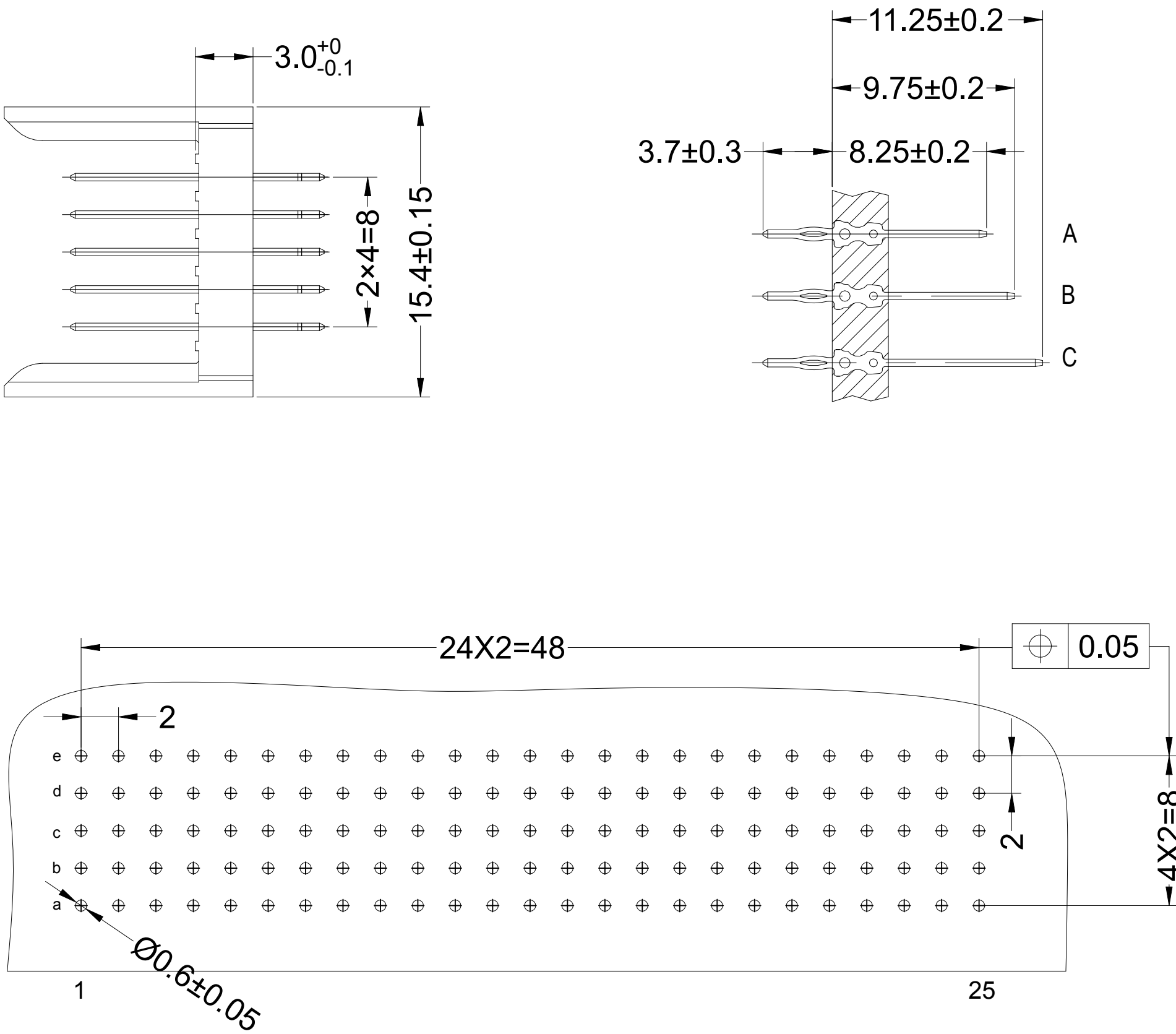
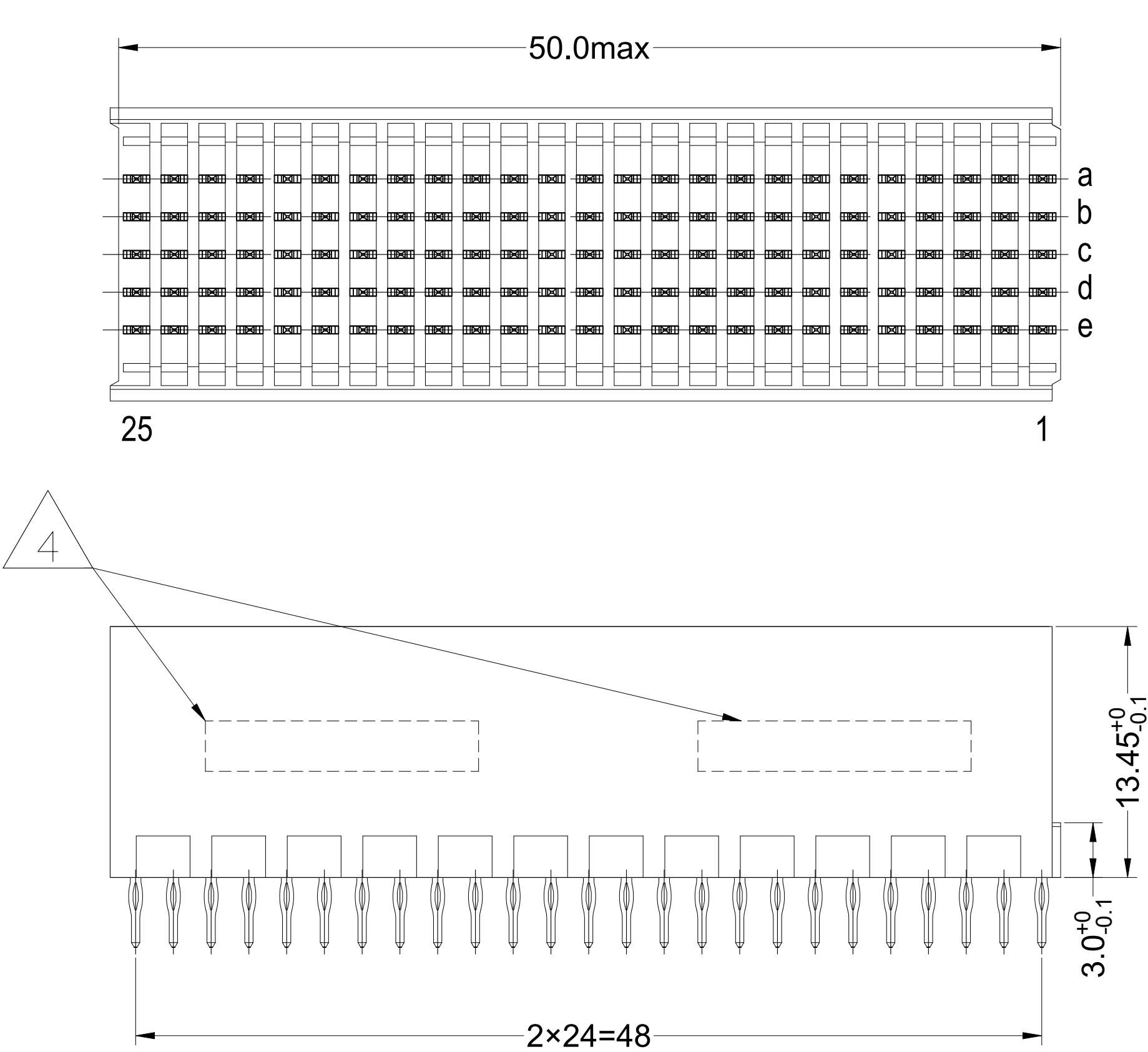
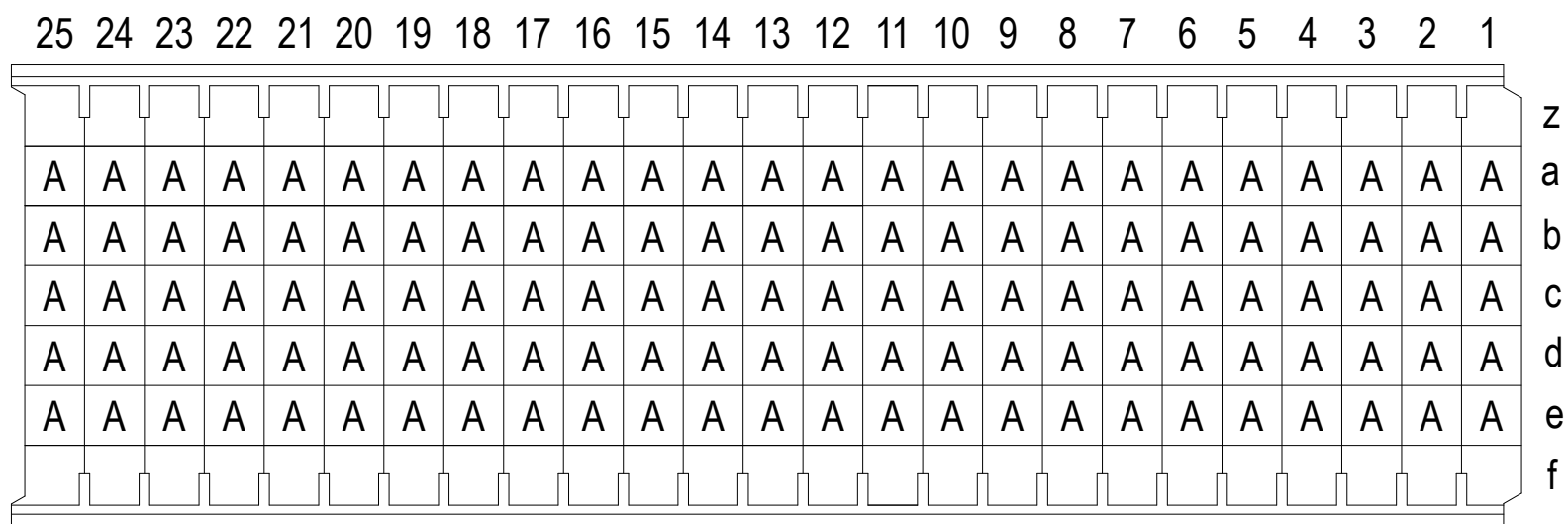


REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
A		INITIAL DRAWING	18OCT2021	TL	HL

D



RECOMMEND PCB-HOLE LAYOUT
COMPONENT SIDE SHOWN
TOLERANCE ± 0.05



- 1

MATERIAL:
CONTACT: COPPER ALLOY.
HOUSING: GLASS-FILLED POLYESTER.
- 2

GENERAL PLATING SPECIFICATION: UNDERPLATING
(ENTIRE CONTACT): 1.27μm MIN NICKEL AND ACTION
PIN: 0.5μm MIN TIN.
FOR PLATING OF MATING SURFACES SEE APPLICABLE
SPECIFICATION REFERENCE FOR EACH DASH NUMBER.
- 3

CONFORMS TO ALL TESTING ACCORDING TO IEC 61076-4-101
PERFORMANCE LEVEL 2.
- 4

CONNECTOR MARKED WITH PART NUMBER AND DATE CODE.

D

C

B

A

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN TONY LI 27MAY2021	TE Connectivity Ltd.	
		CHK ALEX XU 27MAY2021		
DIMENSIONS: mm		APVD HOPE LU 27MAY2021	NAME MALE ASSEMBLY, Z-PACK 2mm HM, 125P TYPE B EON	
		PRODUCT SPEC 108-19082	SIZE A1	
		APPLICATION SPEC 114-160149		
MATERIAL 		WEIGHT 0	DRAWING NO 00779	
		FINISH SEE TABLE	CUSTOMER DRAWING	
		SCALE 4:1	SHEET 1 OF 1	
		REV A		